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Applications of "<u>Embedded - Microcontrollers</u>"

Details	
Product Status	Active
Core Processor	PIC
Core Size	8-Bit
Speed	40MHz
Connectivity	•
Peripherals	POR, WDT
Number of I/O	20
Program Memory Size	3KB (2K x 12)
Program Memory Type	ОТР
EEPROM Size	-
RAM Size	72 x 8
Voltage - Supply (Vcc/Vdd)	4.5V ~ 5.5V
Data Converters	-
Oscillator Type	External
Operating Temperature	0°C ~ 70°C (TA)
Mounting Type	Through Hole
Package / Case	28-DIP (0.600", 15.24mm)
Supplier Device Package	28-PDIP
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic16c57c-40-p

3.0 ARCHITECTURAL OVERVIEW

The high performance of the PIC16C5X family can be attributed to a number of architectural features commonly found in RISC microprocessors. To begin with, the PIC16C5X uses a Harvard architecture in which program and data are accessed on separate buses. This improves bandwidth over traditional von Neumann architecture where program and data are fetched on the same bus. Separating program and data memory further allows instructions to be sized differently than the 8-bit wide data word. Instruction opcodes are 12 bits wide making it possible to have all single word instructions. A 12-bit wide program memory access bus fetches a 12-bit instruction in a single cycle. A twostage pipeline overlaps fetch and execution of instructions. Consequently, all instructions (33) execute in a single cycle except for program branches.

The PIC16C54/CR54 and PIC16C55 address 512 x 12 of program memory, the PIC16C56/CR56 address 1K x 12 of program memory, and the PIC16C57/CR57 and PIC16C58/CR58 address 2K x 12 of program memory. All program memory is internal.

The PIC16C5X can directly or indirectly address its register files and data memory. All special function registers including the program counter are mapped in the data memory. The PIC16C5X has a highly orthogonal (symmetrical) instruction set that makes it possible to carry out any operation on any register using any addressing mode. This symmetrical nature and lack of 'special optimal situations' make programming with the PIC16C5X simple yet efficient. In addition, the learning curve is reduced significantly.

The PIC16C5X device contains an 8-bit ALU and working register. The ALU is a general purpose arithmetic unit. It performs arithmetic and Boolean functions between data in the working register and any register file.

The ALU is 8 bits wide and capable of addition, subtraction, shift and logical operations. Unless otherwise mentioned, arithmetic operations are two's complement in nature. In two-operand instructions, typically one operand is the W (working) register. The other operand is either a file register or an immediate constant. In single operand instructions, the operand is either the W register or a file register.

The W register is an 8-bit working register used for ALU operations. It is not an addressable register.

Depending on the instruction executed, the ALU may affect the values of the Carry (C), Digit Carry (DC), and Zero (Z) bits in the STATUS register. The C and DC bits operate as a borrow and digit borrow out bit, respectively, in subtraction. See the SUBWF and ADDWF instructions for examples.

A simplified block diagram is shown in Figure 3-1, with the corresponding device pins described in Table 3-1 (for PIC16C54/56/58) and Table 3-2 (for PIC16C55/57).

FIGURE 5-3: TIME-OUT SEQUENCE ON POWER-UP (MCLR NOT TIED TO VDD)

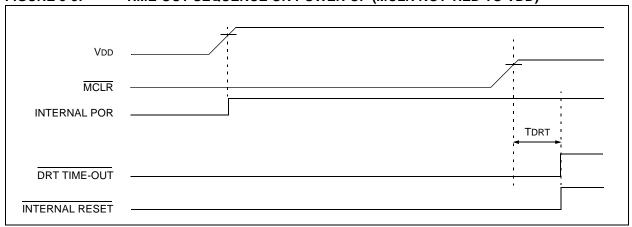


FIGURE 5-4: TIME-OUT SEQUENCE ON POWER-UP (MCLR TIED TO VDD): FAST VDD RISE TIME

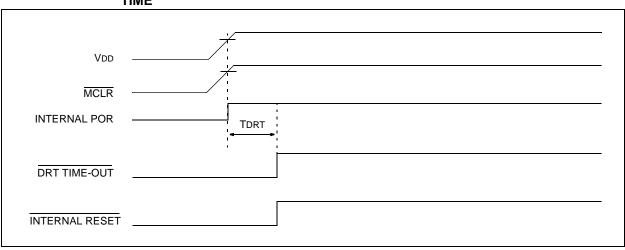
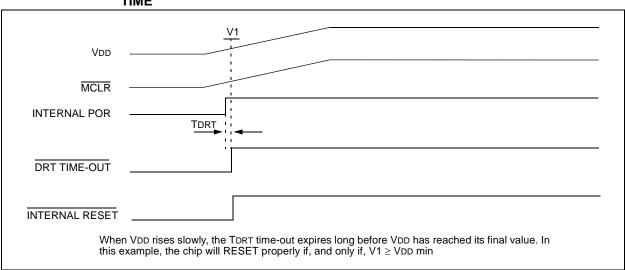


FIGURE 5-5: TIME-OUT SEQUENCE ON POWER-UP (MCLR TIED TO VDD): SLOW VDD RISE TIME



6.2.2 SPECIAL FUNCTION REGISTERS

The Special Function Registers are registers used by the CPU and peripheral functions to control the operation of the device (Table 6-1).

The Special Registers can be classified into two sets. The Special Function Registers associated with the "core" functions are described in this section. Those related to the operation of the peripheral features are described in the section for each peripheral feature.

TABLE 6-1: SPECIAL FUNCTION REGISTER SUMMARY

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on Power-on Reset	Details on Page
N/A	TRIS	IS I/O Control Registers (TRISA, TRISB, TRISC)								1111 1111	35
N/A	OPTION	Contains	s control b	oits to con	figure Ti	mer0 and	Timer0/V	VDT pres	caler	11 1111	30
00h	INDF	Uses co	ntents of	FSR to ac	ddress da	ata memo	ry (not a	physical r	egister)	XXXX XXXX	32
01h	TMR0	Timer0 N	Timer0 Module Register							XXXX XXXX	38
02h ⁽¹⁾	PCL	Low ord	er 8 bits c	of PC						1111 1111	31
03h	STATUS	PA2	PA1	PA0	TO	PD	Z	DC	С	0001 1xxx	29
04h	FSR	Indirect	Indirect data memory address pointer							1xxx xxxx ⁽³⁾	32
05h	PORTA	_	_	_	_	RA3	RA2	RA1	RA0	XXXX	35
06h	PORTB	RB7	RB6	RB5	RB4	RB3	RB2	RB1	RB0	XXXX XXXX	35
07h ⁽²⁾	PORTC	RC7	RC6	RC5	RC4	RC3	RC2	RC1	RC0	xxxx xxxx	35

Legend: x = unknown, u = unchanged, -= unimplemented, read as '0' (if applicable). Shaded cells = unimplemented or unused

Note 1: The upper byte of the Program Counter is not directly accessible. See Section 6.5 for an explanation of how to access these bits.

^{2:} File address 07h is a General Purpose Register on the PIC16C54, PIC16CR54, PIC16C56, PIC16CR56, PIC16C58 and PIC16CR58.

^{3:} These values are valid for PIC16C57/CR57/C58/CR58. For the PIC16C54/CR54/C55/C56/CR56, the value on RESET is 111x xxxx and for MCLR and WDT Reset, the value is 111u uuuu.

PIC16C5X

NOTES:

ADDWF								
Syntax:	[lab	el]	ADDWF	f,d				
Operands:	$0 \le f \le 31$ $d \in [0,1]$							
Operation:	(W)	+ (f)	\rightarrow (dest)					
Status Affected:	C, D)C, Z	<u> </u>					
Encoding:	00	01	11df	ff	ff			
Description:	Add the contents of the W register 'f'. If 'd' is 0 the resis stored in the W register. If 'd' '1' the result is stored back in register 'f'.							
Words:	1	1						
Cycles:	1							
Example:	ADD	ADDWF TEMP_RE			0			
Before Instr	uctio	n						
W		=	0x17					
TEMP_I		=	0xC2					
After Instruc	ction							
W		=	0xD9					
TEMP_I	REG	=	0xC2					

ANDWF	AND W with f							
Syntax:	[label] ANDWF f,d							
Operands:	$0 \le f \le 31$ $d \in [0,1]$							
Operation:	(W) .AND. (f) \rightarrow (dest)							
Status Affected:	Z							
Encoding:	0001 01df ffff							
Description:	The contents of the W register are AND'ed with register 'f'. If 'd' is 0 the result is stored in the W register. If 'd' is '1' the result is stored back in register 'f'.							
Words:	1							
Cycles:	1							
Example:	ANDWF TEMP_REG, 1							
Example: ANDWF TEMP_REG, 1 Before Instruction W = 0x17 TEMP_REG = 0xC2 After Instruction W = 0x17 TEMP_REG = 0x02								

ANDLW	AND literal with W							
Syntax:	[label] ANDLW k							
Operands:	$0 \leq k \leq 255$							
Operation:	(W).AND. (k) \rightarrow (W)							
Status Affected:	Z							
Encoding:	1110 kkkk kkkk							
Description:	The contents of the W register are AND'ed with the eight-bit literal 'k'. The result is placed in the W register.							
Words:	1							
Cycles:	1							
Example:	ANDLW H'5F'							
Before Instruction W = 0xA3 After Instruction W = 0x03								

BCF	Bit Clea	r f						
Syntax:	[label]	BCF f,t)					
Operands:	$0 \le f \le 31$ $0 \le b \le 7$							
Operation:	$0 \rightarrow (f < b >)$							
Status Affected: None								
Encoding:	0100	bbbf	ffff					
Description:	Bit 'b' in register 'f' is cleared.							
Words:	1							
Cycles:	1							
Example:	BCF FLAG_REG, 7							
Before Instruction								
FLAG_R After Instruct	0xC7							
FLAG_R		0x47						

PIC16C5X

BSF	Bit Set f							
Syntax:	[label] BSF f,b							
Operands:	$\begin{aligned} 0 &\leq f \leq 31 \\ 0 &\leq b \leq 7 \end{aligned}$							
Operation:	$1 \rightarrow (f < b >)$							
Status Affected:	ected: None							
Encoding:	0101 bbbf ffff							
Description: Bit 'b' in register 'f' is set.								
Words:	1							
Cycles:	1							
Example:	BSF	FLAG_RE	EG, 7					
Before Instruction FLAG_REG = 0x0A After Instruction								
FLAG_F	REG = 0	A8x(

BTFSC	Bit Test f, Skip if Clear								
Syntax:	[label] BTFSC f,b								
Operands:	$\begin{array}{l} 0 \leq f \leq 31 \\ 0 \leq b \leq 7 \end{array}$								
Operation:	skip if $(f < b >) = 0$								
Status Affected:	None								
Encoding:	0110 bbbf ffff								
Description:	If bit 'b' in register 'f' is 0 then the next instruction is skipped. If bit 'b' is 0 then the next instruction fetched during the current instruction execution is discarded, and a NOP is executed instead, making this a 2-cycle instruction.								
Words:	1								
Cycles:	1(2)								
Example:	HERE BTFSC FLAG,1 FALSE GOTO PROCESS_CODE TRUE • • •	E							
Before Instru PC After Instruct	= address (HERE)								
if FLAG PC if FLAG PC	= address (TRUE);								

BTFSS	Bit Test f, Skip if Set								
Syntax:	[label] BTFSS f,b								
Operands:	$0 \le f \le 31$ $0 \le b < 7$								
Operation:	skip if $(f < b >) = 1$								
Status Affected:	None								
Encoding:	0111 bbbf ffff								
Description:	If bit 'b' in register 'f' is '1' then the next instruction is skipped. If bit 'b' is '1', then the next instruction fetched during the current instruction execution, is discarded and a NOP is executed instead, making this a 2-cycle instruction.								
Words:	1								
Cycles:	1(2)								
Example:	HERE BTFSS FLAG,1 FALSE GOTO PROCESS_CODE TRUE • • •	:							
Before Instru PC After Instruc If FLAG- PC if FLAG- PC	= address (HERE) ction <1> = 0,								

12.4 DC Characteristics: PIC16C54/55/56/57-RC, XT, 10, HS, LP (Commercial) PIC16C54/55/56/57-RCI, XTI, 10I, HSI, LPI (Industrial)

DC CH	ARACTE	RISTICS	Standard Operating Conditions (unless otherwise specified) Operating Temperature $0^{\circ}C \le TA \le +70^{\circ}C$ for commercial $-40^{\circ}C \le TA \le +85^{\circ}C$ for industrial					
Param No.	Symbol	Characteristic/Device	Min	Тур†	Max	Units	Conditions	
D030	VIL	Input Low Voltage I/O ports MCLR (Schmitt Trigger) T0CKI (Schmitt Trigger) OSC1 (Schmitt Trigger) OSC1 (Schmitt Trigger)	Vss Vss Vss Vss Vss	_ _ _ _	0.2 VDD 0.15 VDD 0.15 VDD 0.15 VDD 0.3 VDD	V V V V	Pin at hi-impedance PIC16C5X-RC only ⁽³⁾ PIC16C5X-XT, 10, HS, LP	
D040	VIH	Input High Voltage I/O ports I/O ports I/O ports MCLR (Schmitt Trigger) TOCKI (Schmitt Trigger) OSC1 (Schmitt Trigger) OSC1 (Schmitt Trigger)	0.45 VDD 2.0 0.36 VDD 0.85 VDD 0.85 VDD 0.85 VDD 0.7 VDD		VDD VDD VDD VDD VDD VDD	V V V V V	For all VDD ⁽⁴⁾ 4.0V < VDD ≤ 5.5V ⁽⁴⁾ VDD > 5.5V PIC16C5X-RC only ⁽³⁾ PIC16C5X-XT, 10, HS, LP	
D050	VHYS	Hysteresis of Schmitt Trigger inputs	0.15 VDD*	_	_	V		
D060	IIL	Input Leakage Current ^(1,2) I/O ports MCLR MCLR TOCKI OSC1	-1 -5 -3 -3	0.5 — 0.5 0.5 0.5	+1 +5 +3 +3	μΑ μΑ μΑ μΑ μΑ	For Vdd \leq 5.5V: VSS \leq VPIN \leq VDD, pin at hi-impedance VPIN = VSS + 0.25V VPIN = VDD VSS \leq VPIN \leq VDD VSS \leq VPIN \leq VDD, PIC16C5X-XT, 10, HS, LP	
D080	Vol	Output Low Voltage I/O ports OSC2/CLKOUT	_	_	0.6 0.6	V V	IOL = 8.7 mA, VDD = 4.5V IOL = 1.6 mA, VDD = 4.5V, PIC16C5X-RC	
D090	Voн	Output High Voltage ⁽²⁾ I/O ports OSC2/CLKOUT	VDD - 0.7 VDD - 0.7	_ _		V V	IOH = -5.4 mA, VDD = 4.5V IOH = -1.0 mA, VDD = 4.5V, PIC16C5X-RC	

^{*} These parameters are characterized but not tested.

- 2: Negative current is defined as coming out of the pin.
- **3:** For PIC16C5X-RC devices, the OSC1/CLKIN pin is a Schmitt Trigger input. It is not recommended that the PIC16C5X be driven with external clock in RC mode.
- 4: The user may use the better of the two specifications.

[†] Data in the Typical ("Typ") column is based on characterization results at 25°C. This data is for design guidance only and is not tested.

Note 1: The leakage current on the MCLR/VPP pin is strongly dependent on the applied voltage level. The specified levels represent normal operating conditions. Higher leakage current may be measured at different input voltage.

12.5 DC Characteristics: PIC16C54/55/56/57-RCE, XTE, 10E, HSE, LPE (Extended)

			Standard Operating Conditions (unless otherwise specified) Operating Temperature $-40^{\circ}\text{C} \le \text{TA} \le +125^{\circ}\text{C}$ for extended					
Param No.	Symbol	Characteristic	Min	Typ†	Max	Units	Conditions	
D030	VIL	Input Low Voltage I/O ports MCLR (Schmitt Trigger) TOCKI (Schmitt Trigger) OSC1 (Schmitt Trigger) OSC1 (Schmitt Trigger)	Vss Vss Vss Vss Vss	11111	0.15 VDD 0.15 VDD 0.15 VDD 0.15 VDD 0.3 VDD	V V V V	Pin at hi-impedance PIC16C5X-RC only ⁽³⁾ PIC16C5X-XT, 10, HS, LP	
D040	VHYS	Input High Voltage I/O ports I/O ports I/O ports MCLR (Schmitt Trigger) TOCKI (Schmitt Trigger) OSC1 (Schmitt Trigger) OSC1 (Schmitt Trigger) Hysteresis of Schmitt	0.45 VDD 2.0 0.36 VDD 0.85 VDD 0.85 VDD 0.85 VDD 0.7 VDD		VDD VDD VDD VDD VDD VDD VDD VDD	V V V V V	For all $VDD^{(4)}$ $4.0V < VDD \le 5.5V^{(4)}$ VDD > 5.5 V PIC16C5X-RC only ⁽³⁾ PIC16C5X-XT, 10, HS, LP	
D060	lι∟	Trigger inputs Input Leakage Current (1,2) I/O ports MCLR MCLR TOCKI OSC1	-1 -5 -3 -3	0.5 0.5 0.5 0.5	+1 +5 +3 +3	μΑ μΑ μΑ μΑ μΑ	For VDD \leq 5.5 V: VSS \leq VPIN \leq VDD, pin at hi-impedance VPIN = VSS + 0.25V VPIN = VDD VSS \leq VPIN \leq VDD VSS \leq VPIN \leq VDD, PIC16C5X-XT, 10, HS, LP	
D080	Vol	Output Low Voltage I/O ports OSC2/CLKOUT		_	0.6 0.6	V V	IOL = 8.7 mA, VDD = 4.5V IOL = 1.6 mA, VDD = 4.5V, PIC16C5X-RC	
D090	Voн	Output High Voltage ⁽²⁾ I/O ports OSC2/CLKOUT	VDD - 0.7 VDD - 0.7	_		V V	IOH = -5.4 mA, VDD = 4.5V IOH = -1.0 mA, VDD = 4.5V, PIC16C5X-RC	

^{*} These parameters are characterized but not tested.

[†] Data in the Typical ("Typ") column is based on characterization results at 25°C. This data is for design guidance only and is not tested.

Note 1: The leakage current on the MCLR/VPP pin is strongly dependent on the applied voltage level. The specified levels represent normal operating conditions. Higher leakage current may be measured at different input voltage.

^{2:} Negative current is defined as coming out of the pin.

^{3:} For PIC16C5X-RC devices, the OSC1/CLKIN pin is a Schmitt Trigger input. It is not recommended that the PIC16C5X be driven with external clock in RC mode.

^{4:} The user may use the better of the two specifications.

FIGURE 14-19: PORTA, B AND C IOH vs. Voh, VDD = 3 V

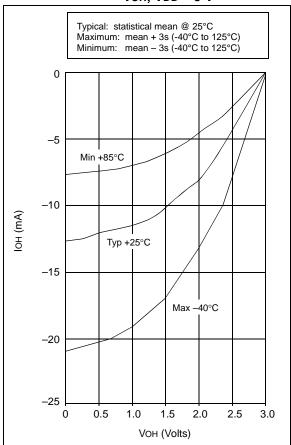
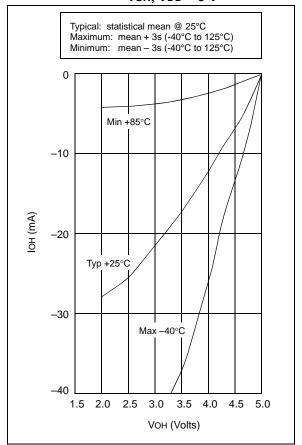


FIGURE 14-20: PORTA, B AND C IOH vs. Voh, VDD = 5 V



15.6 Timing Diagrams and Specifications

AC Characteristics

FIGURE 15-2: EXTERNAL CLOCK TIMING - PIC16C54A

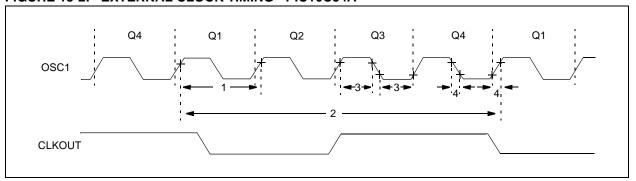


TABLE 15-1: EXTERNAL CLOCK TIMING REQUIREMENTS - PIC16C54A

Standard Operating Conditions (unless otherwise specified)

Operating Temperature $0^{\circ}C \le TA \le +70^{\circ}C$ for commercial $-40^{\circ}C \le TA \le +85^{\circ}C$ for industrial

-20°C \leq TA \leq +85°C for industrial - PIC16LV54A-02I

 -40° C \leq TA \leq +125 $^{\circ}$ C for extended

Param Symbol Characteristic Min Max Units Conditions Typ† No. External CLKIN Fre-Fosc DC MHz XT osc mode 4.0 quency⁽¹⁾ XT osc mode (PIC16LV54A) DC 2.0 MHz MHz HS osc mode (04) DC 4.0 DC 10 MHz HS osc mode (10) DC 20 MHz HS osc mode (20) DC 200 kHz LP osc mode Oscillator Frequency⁽¹⁾ DC MHz RC osc mode 4.0 DC 2.0 MHz RC osc mode (PIC16LV54A) 0.1 4.0 MHz XT osc mode MHz XT osc mode (PIC16LV54A) 2.0 0.1 4.0 MHz HS osc mode (04) 4.0 4.0 10 MHz HS osc mode (10) 20 MHz HS osc mode (20) 4.0 200 LP osc mode 5.0 kHz

Note 1: All specified values are based on characterization data for that particular oscillator type under standard operating conditions with the device executing code. Exceeding these specified limits may result in an unstable oscillator operation and/or higher than expected current consumption.

When an external clock input is used, the "max" cycle time limit is "DC" (no clock) for all devices.

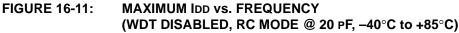
2: Instruction cycle period (TcY) equals four times the input oscillator time base period.

^{*} These parameters are characterized but not tested.

[†] Data in the Typical ("Typ") column is based on characterization results at 25°C. This data is for design guidance only and is not tested.

Typical: statistical mean @ 25°C Maximum: mean + 3s (-40°C to 125°C) Minimum: mean - 3s (-40°C to 125°C) 10000 1000 IDD (μA) 100 10 0.1 10 Freq (MHz)

FIGURE 16-10: TYPICAL IDD vs. FREQUENCY (WDT DISABLED, RC MODE @ 20 PF, 25°C)



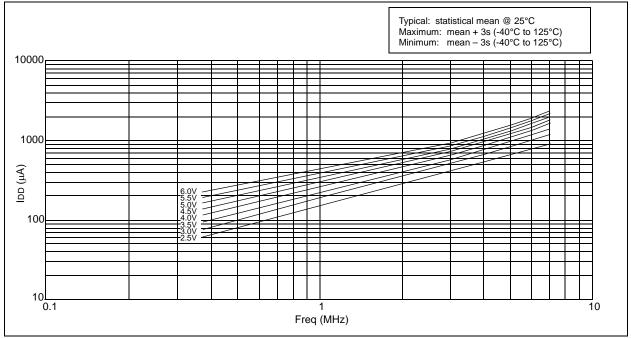


FIGURE 18-6: TYPICAL IPD vs. VDD, WATCHDOG ENABLED (25°C)

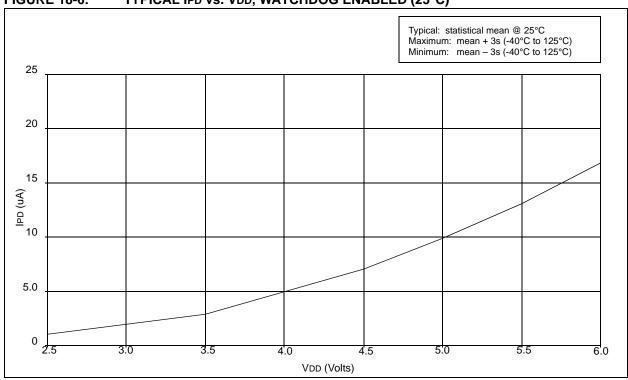
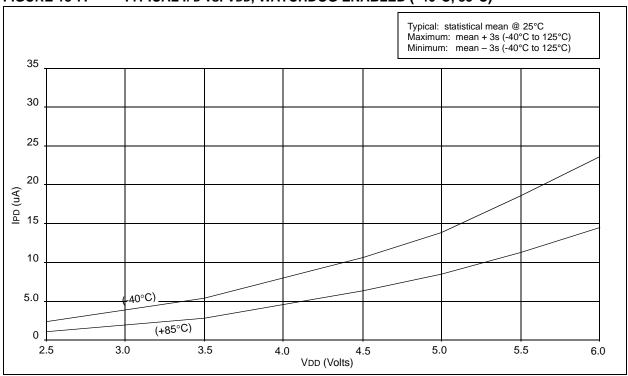


FIGURE 18-7: TYPICAL IPD vs. VDD, WATCHDOG ENABLED (-40°C, 85°C)



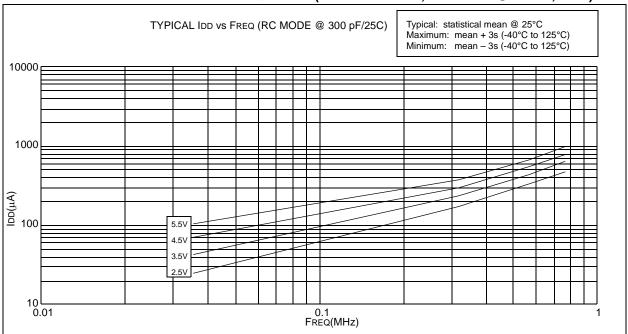
10

TYPICAL IDD vs FREQ(RC MODE @ 100 pF/25C) Typical: statistical mean @ 25°C Maximum: mean + 3s (-40°C to 125°C) Minimum: mean - 3s (-40°C to 125°C) 10000 1000 IDD(μA) 5.5\ 100 3.5

TYPICAL IDD vs. FREQUENCY (WDT DISABLED, RC MODE @ 100 PF, 25°C) FIGURE 18-12:



FREQ(MHz)



10 0.1

FIGURE 18-16: PORTA, B AND C IOH vs. Voh, VDD = 5 V

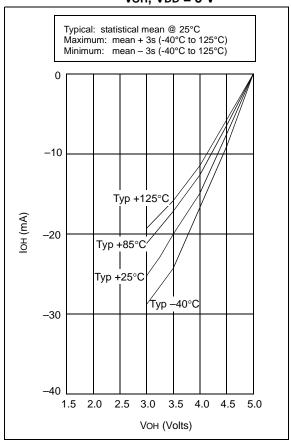
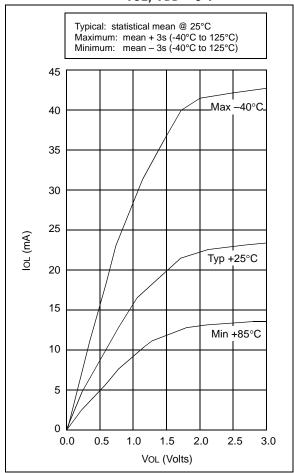


FIGURE 18-17: PORTA, B AND C IOL vs. Vol, VDD = 3 V



19.4 Timing Diagrams and Specifications

FIGURE 19-3: EXTERNAL CLOCK TIMING - PIC16C5X-40

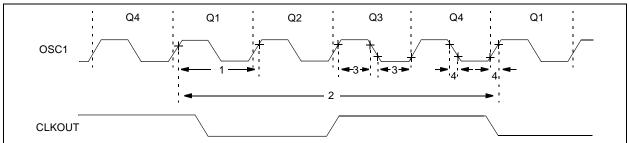


TABLE 19-1: EXTERNAL CLOCK TIMING REQUIREMENTS - PIC16C5X-40

AC Chara	AC Characteristics Standard Operating Conditions (unless otherwise specified Operating Temperature $0^{\circ}C \le TA \le +70^{\circ}C$ for commercial					1)	
Param No.	Symbol	Characteristic		Typ†	Max	Units	Conditions
	Fosc	External CLKIN Frequency ⁽¹⁾	20	_	40	MHz	HS osc mode
1	Tosc	External CLKIN Period ⁽¹⁾	25	_	_	ns	HS osc mode
2	Tcy	Instruction Cycle Time ⁽²⁾	_	4/Fosc	_	_	
3	TosL, TosH	Clock in (OSC1) Low or High Time	6.0*	_	_	ns	HS oscillator
4	TosR, TosF	Clock in (OSC1) Rise or Fall Time	_	_	6.5*	ns	HS oscillator

^{*} These parameters are characterized but not tested.

- Note 1: All specified values are based on characterization data for that particular oscillator type under standard operating conditions with the device executing code. Exceeding these specified limits may result in an unstable oscillator operation and/or higher than expected current consumption.

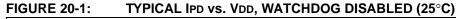
 When an external clock input is used, the "max" cycle time limit is "DC" (no clock) for all devices.
 - 2: Instruction cycle period (TcY) equals four times the input oscillator time base period.

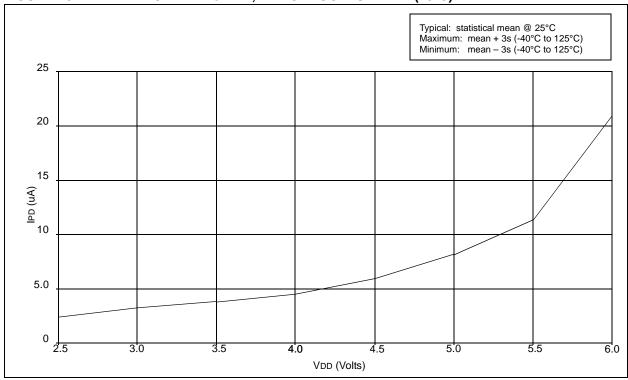
[†] Data in the Typical ("Typ") column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

20.0 DEVICE CHARACTERIZATION - PIC16LC54C 40MHz

The graphs and tables provided following this note are a statistical summary based on a limited number of samples and are provided for informational purposes only. The performance characteristics listed herein are not tested or guaranteed. In some graphs or tables, the data presented may be outside the specified operating range (e.g., outside specified power supply range) and therefore outside the warranted range.

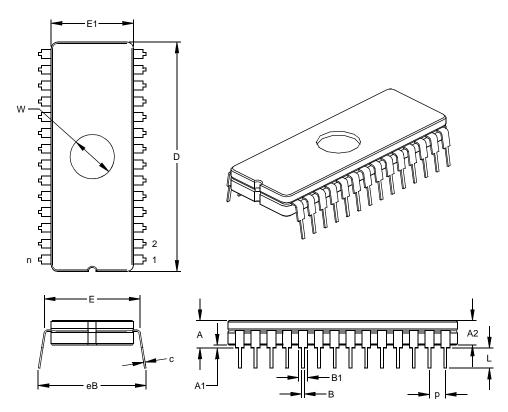
"Typical" represents the mean of the distribution at 25°C. "Maximum" or "minimum" represents (mean + 3σ) or (mean – 3σ) respectively, where σ is a standard deviation, over the whole temperature range.





28-Lead Ceramic Dual In-line with Window (JW) - 600 mil (CERDIP)

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



	Units		INCHES*			MILLIMETERS		
Dimension	Limits	MIN	NOM	MAX	MIN	NOM	MAX	
Number of Pins	n		28			28		
Pitch	р		.100			2.54		
Top to Seating Plane	Α	.195	.210	.225	4.95	5.33	5.72	
Ceramic Package Height	A2	.155	.160	.165	3.94	4.06	4.19	
Standoff	A1	.015	.038	.060	0.38	0.95	1.52	
Shoulder to Shoulder Width	Е	.595	.600	.625	15.11	15.24	15.88	
Ceramic Pkg. Width	E1	.514	.520	.526	13.06	13.21	13.36	
Overall Length	D	1.430	1.460	1.490	36.32	37.08	37.85	
Tip to Seating Plane	L	.125	.138	.150	3.18	3.49	3.81	
Lead Thickness	С	.008	.010	.012	0.20	0.25	0.30	
Upper Lead Width	B1	.050	.058	.065	1.27	1.46	1.65	
Lower Lead Width	В	.016	.020	.023	0.41	0.51	0.58	
Overall Row Spacing §	eВ	.610	.660	.710	15.49	16.76	18.03	
Window Diameter	W	.270	.280	.290	6.86	7.11	7.37	

^{*} Controlling Parameter § Significant Characteristic JEDEC Equivalent: MO-103 Drawing No. C04-013

PIC16C5X

M	Q
MCLR Reset	Q cycles
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